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The technical content of this TAOS datasheet is still valid.

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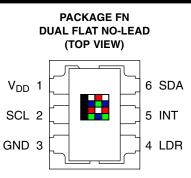
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Features

- RGB and Clear Color Sensing and Proximity Detection in a Single Device
- Color Light Sensing with IR-Blocking Filter
- Programmable Analog Gain and Integration Time
- 3,800,000:1 Dynamic Range
- Very High Sensitivity Ideally Suited for Operation Behind Dark Glass
- Proximity Detection
 - Ambient Light Rejection
 - Programmable Integration Time
 - Current Sink Driver for External IR LED
- Maskable Light and Proximity Interrupt
- Programmable Upper and Lower Thresholds with Persistence Filter
- Power Management
 - Low Power 2.5-μA Sleep State
 - 65-μA Wait State withProgrammable Wait State Time from 2.4 ms to > 7 Seconds
- I²C Fast Mode Compatible Interface
 - Data Rates up to 400 kbit/s
 - Input Voltage Levels Compatible with V_{DD} or 1.8 V Bus
- Register Set and Pin Compatible with the TCS3x71 Series
- Small 2 mm × 2.4 mm Dual Flat No-Lead (FN) Package

TCS3772 COLOR LIGHT-TO-DIGITAL CONVERTER with PROXIMITY SENSING TAOS145B - SEPTEMBER 2012



Package Drawing Not to Scale

Applications

- RGB LED Backlight Control
- Ambient Light Color Temperature Sensing
- Cell Phone Touch Screen Disable
- Mechanical Switch Replacement
- Industrial Process Control
- Medical Diagnostics

End Products and Market Segments

- HDTVs, Mobile Handsets, Tablets, and Portable Media Payers
- Medical and Commercial Instrumentation
- Toys
- Solid State and General Lighting

Description

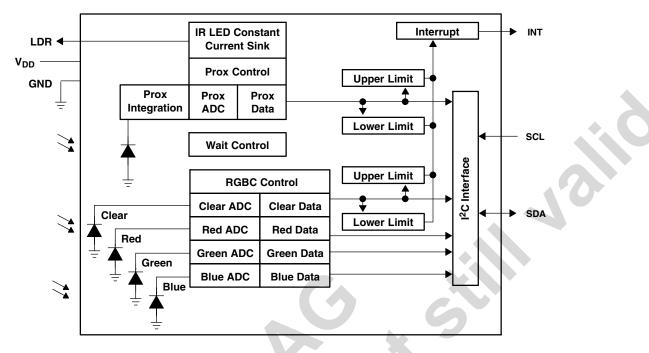
The TCS3772 device family provides red, green, blue, and clear (RGBC) light sensing and, when coupled with an external IR LED, proximity detection. These devices detect light intensity under a variety of lighting conditions and through a variety of attenuation materials, including dark glass. The proximity detection feature allows a large dynamic range of operation for accurate short distance detection, such as in a cell phone, for detecting when the user positions the phone close to their ear. An internal state machine provides the ability to put the device into a low power state in between proximity and RGBC measurements providing very low average power consumption.

The color sensing feature is useful in applications such as LED RGB backlight control, solid state lighting, reflected LED color sampler, or fluorescent light color temperature detection. With the addition of an IR blocking filter, the device is an excellent ambient light sensor, color temperature monitor, and general purpose color sensor.

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Functional Block Diagram



Detailed Description

The TCS3772 is a next-generation digital color light sensor device containing four integrating analog-to-digital converters (ADCs) that integrate currents from photodiodes. The device contains a 3 × 4 photodiode array used for color measurements and a 1×4 photodiode array used for proximity measurements. Integration of all color sensing channels occurs simultaneously. Upon completion of the conversion cycle, the conversion result is transferred to the corresponding data registers. The transfers are double-buffered to ensure that the integrity of the data is maintained. Communication with the device is accomplished through a fast (up to 400 kHz), two-wire I²C serial bus for easy connection to a microcontroller or embedded controller.

The device provides a separate pin for level-style interrupts. The interrupt feature simplifies and improves system efficiency by eliminating the need to poll a sensor for a light intensity value. When interrupts are enabled, an interrupt is generated when the value of a clear channel or proximity conversion is greater than an upper threshold or less than a lower threshold. Once the interrupt is asserted, it remains asserted until cleared by the controlling firmware. In addition, a programmable interrupt persistence filter allows the user to set the number of consecutive clear channel or proximity conversions outside of the threshold region that are necessary to trigger an interrupt. Interrupt thresholds and persistence filter settings are configured independently for both clear and proximity.

Proximity detection requires only a single external IR LED. An internal LED driver can be configured to provide a constant current sink of 12.5 mA, 25 mA, 50 mA, or 100 mA of current. No external current limiting resistor is required. The number of proximity LED pulses can be programmed from 1 to 255 pulses. Each pulse has a 14-us period.

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TERMINAL TYPE DESCRIPTION NAME NO. GND 3 Power supply ground. All voltages are referenced to GND. INT 5 0 Interrupt - open drain (active low). LDR 4 0 LED driver for proximity emitter - open drain. I²C serial clock input terminal — clock signal for I²C serial data. SCL 2 L SDA 6 I/O I²C serial data I/O terminal — serial data I/O for I²C Supply voltage. V_{DD} 1

Terminal Functions

Available Options

DEVICE	ADDRESS	PACKAGE – LEADS	INTERFACE DESCRIPTION	ORDERING NUMBER
TCS37721 [†]	0x39	FN–6 I ² C Vbus = V _{DD} Interface		TCS37721FN
TCS37723 [†]	0x39	FN–6	I ² C Vbus = 1.8 V Interface	TCS37723FN
TCS37725 [†]	0x29	FN–6	I ² C Vbus = V _{DD} Interface	TCS37725FN
TCS37727	0x29	FN–6	I ² C Vbus = 1.8 V Interface	TCS37727FN

[†] Contact TAOS for availability.

Absolute Maximum Ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{DD} (Note 1)	3.8 V
Input terminal voltage	
Output terminal voltage (except LDR)	–0.5 V to 3.8 V
Output terminal voltage (LDR)	–0.5 V to 3.8 V
Output terminal current (except LDR)	–1 mA to 20 mA
Storage temperature range, T _{stg}	
ESD tolerance, human body model	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltages are with respect to GND.

Recommended Operating Conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V_{DD} (TCS37721 & TCS37725) (I ² C $V_{bus} = V_{DD}$)	2.7	3	3.6	V
Supply voltage, V_{DD} (TCS37723 & TCS37727) (I ² C V _{bus} = 1.8 V)	2.7	3	3.3	V
Operating free-air temperature, T _A	-30		70	°C

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Operating Characteristics, V_{DD} = 3 V, T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
		Active — LDR pulses off		235	330	
I _{DD}	Supply current	oply current Wait state		65		μA
		Sleep state — no I ² C activity		2.5	10	
v		3 mA sink current	0		0.4	
V _{OL}	INT, SDA output low voltage	6 mA sink current	0		0.6	V
I _{LEAK}	Leakage current, SDA, SCL, INT pins		-5		5	μA
I _{LEAK}	Leakage current, LDR pin		-5		5	μA
.,		TCS37721 & TCS37725	0.7 V _{DD}			5
VIH	SCL, SDA input high voltage	TCS37723 & TCS37727	1.25			V
		TCS37721 & TCS37725			0.3 V _{DD}	
VIL	SCL, SDA input low voltage	TCS37723 & TCS37727			0.54	V

Optical Characteristics, V_{DD} = 3 V, T_A = 25°C, AGAIN = 16×, ATIME = 0xF6 (unless otherwise noted) (Note 1)

		TEST	Ree	d Chann	nel	Gree	en Chai	nnel	Blu	e Chan	nel	Cle	ar Char	nnel	
F	PARAMETER	CONDITIONS	MIN	ТҮР	MAX	MIN	TYP	МАХ	MIN	TYP	МАХ	MIN	ТҮР	MAX	UNIT
		$\lambda_D = 465 \text{ nm}$ Note 2	0%		15%	10%	1	42%	65%		88%	11.0	13.8	16.6	
R _e	Irradiance responsivity	$\lambda_D = 525 \text{ nm}$ Note 3	4%		25%	60%		85%	10%		45%	13.2	16.6	20.0	counts/ μW/ cm ²
		$\lambda_D = 615 \text{ nm}$ Note 4	80%		110%	0%		14%	5%		24%	15.6	19.5	23.4	GIII

NOTES: 1. The percentage shown represents the ratio of the respective red, green, or blue channel value to the clear channel value.

2. The 465 nm input irradiance is supplied by an InGaN light-emitting diode with the following characteristics: dominant wavelength λ_D = 465 nm, spectral halfwidth $\Delta\lambda^{1/2}$ = 22 nm.

3. The 525 nm input irradiance is supplied by an InGaN light-emitting diode with the following characteristics: dominant wavelength λ_D = 525 nm, spectral halfwidth $\Delta \lambda \frac{1}{2}$ = 35 nm.

4. The 615 nm input irradiance is supplied by a AIInGaP light-emitting diode with the following characteristics: dominant wavelength λ_D = 615 nm, spectral halfwidth $\Delta \lambda \frac{1}{2}$ = 15 nm.

RGBC Characteristics, VDD = 3 V, TA = 25°C, AGAIN = 16×, AEN = 1 (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
Dark ADC count value	$E_e = 0$, AGAIN = 60×, ATIME = 0xD6 (100 ms)	0	1	5	counts
ADC integration time step size	ATIME = 0xFF	2.27	2.4	2.56	ms
ADC number of integration steps (Note 5)		1		256	steps
ADC counts per step (Note 5)		0		1024	counts
ADC count value (Note 5)	ATIME = 0xC0 (153.6 ms)	0		65535	counts
	4×	3.8	4	4.2	
Gain scaling, relative to 1× gain setting	16×	15	16	16.8	×
Sound	60×	58	60	63	

NOTE 5: Parameter ensured by design and is not tested.



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Proximity Characteristics, $V_{DD} = 3 V$, $T_A = 25^{\circ}C$, PEN = 1 (unless otherwise noted)

	PARAMETER	TEST COND	ITIONS	MIN	TYP	MAX	UNIT
I _{DD}	Supply current	LDR pulse on			3		mA
	ADC conversion time step size	PTIME = 0xFF		2.27	2.4	2.56	ms
	ADC number of integration steps (Note 1)			1		256	steps
	ADC counts per step (Note 1)	PTIME = 0xFF		0		1023	counts
	ADC count value	λ_p = 850 nm, E _e = 770.1 µW/cm ² PPULSE = 1 (Note 3)	² , PTIME = 0xFB,	1350		1900	counts
	ADC output responsivity	λ_p = 850 nm, PTIME = 0xFF, PPULSE = 1 (Note 3)			0.211	0.247	counts/ µW/cm ²
	Noise (Notes 1, 2, 3)	E _e = 0, PTIME = 0xFF, PPULSE		2		% FS	
	LED pulse count (Note 1)			0		255	pulses
	LED pulse period				14.0		μs
	LED pulse width — LED on time				6.3		μs
			PDRIVE = 0	80	106	132	
		ISINK sink current @ 1.6 V,	PDRIVE = 1		50		
	LED drive current	LDR pin	PDRIVE = 2		25		mA
		PDRIVE = 3			12.5		
	Maximum operating distance (Notes 1, 4, 5)	$\begin{array}{l} \mbox{PDRIVE} = 0 \ (100 \ \mbox{mA}), \mbox{ PPULSE} = 64 \\ \mbox{Emitter:} \ \lambda_p = 850 \ \mbox{nm}, \ 20^\circ \ \mbox{half angle, and } 60 \ \mbox{mW/sr} \\ \mbox{Object:} \ \ 16 \times 20 \ \mbox{inch, } 90\% \ \mbox{reflective Kodak Gray Card} \\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $			30		inches

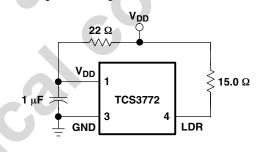
NOTES: 1. Parameter is ensured by design or characterization and is not tested.

2. Proximity noise is defined as one standard deviation of 600 samples.

3. Proximity noise typically increases as √PPULSE

4. Greater operating distances are achievable with appropriate optical system design considerations. See available TAOS application notes for additional information.

- 5. Maximum operating distance is dependent upon emitter and the reflective properties of the object's surface.
- 6. Proximity noise test was done using the following circuit:



Wait Characteristics, $V_{DD} = 3 V$, $T_A = 25^{\circ}C$, WEN = 1 (unless otherwise noted)

PARAMETER	TEST CONDITIONS	CHANNEL	MIN	TYP	MAX	UNIT
Wait step size	WTIME = 0xFF		2.27	2.4	2.56	ms
Wait number of steps (Note 7)			1		256	steps

NOTE 7: Parameter ensured by design and is not tested.

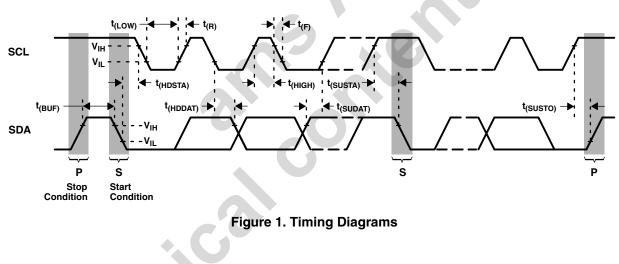


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AC Electrical Characteristics, V_{DD} = 3 V, T_A = 25°C (unless otherwise noted)

	PARAMETER [†]	TEST CONDITIONS	MIN	TYP I	MAX	UNIT
f _(SCL)	Clock frequency (I ² C only)		0		400	kHz
t _(BUF)	Bus free time between start and stop condition		1.3			μs
t _(HDSTA)	Hold time after (repeated) start condition. After this period, the first clock is generated.		0.6			μs
t _(SUSTA)	Repeated start condition setup time		0.6			μs
t _(SUSTO)	Stop condition setup time		0.6			μs
t _(HDDAT)	Data hold time		0			μs
t _(SUDAT)	Data setup time		100			ns
t _(LOW)	SCL clock low period		1.3			μs
t _(HIGH)	SCL clock high period		0.6			μs
t _F	Clock/data fall time				300	ns
t _R	Clock/data rise time				300	ns
C _i	Input pin capacitance				10	pF

[†] Specified by design and characterization; not production tested.

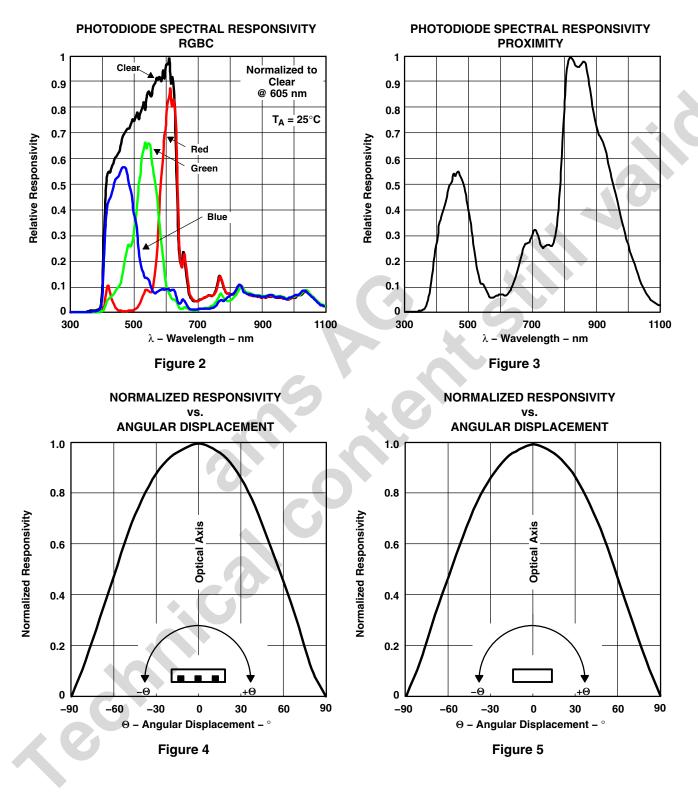


PARAMETER MEASUREMENT INFORMATION

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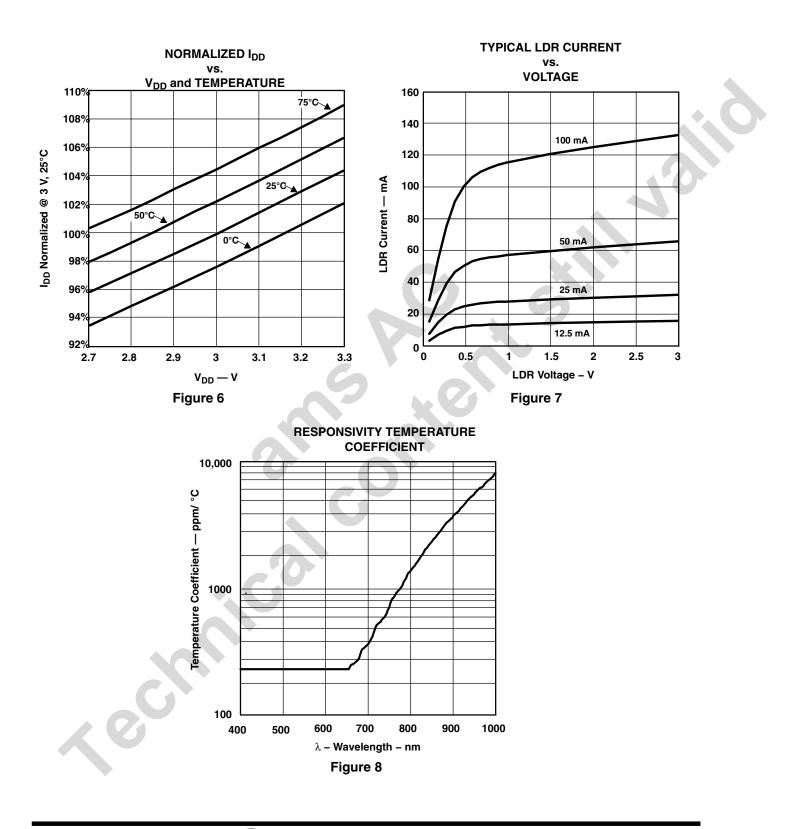
TYPICAL CHARACTERISTICS

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TYPICAL CHARACTERISTICS







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PRINCIPLES OF OPERATION

System State Machine

The TCS3772 provides control of RGBC, proximity detection, and power management functionality through an internal state machine (Figure 9). After a power-on-reset, the device is in the sleep mode. As soon as the PON bit is set, the device will move to the start state. It will then continue through the Prox, Wait, and RGBC states. If these states are enabled, the device will execute each function. If the PON bit is set to 0, the state machine will continue until all conversions are completed and then go into a low power sleep mode.

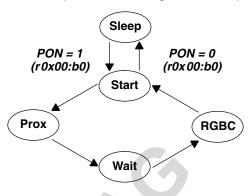


Figure 9. Simplified State Diagram

NOTE: In this document, the nomenclature uses the bit field name in italics followed by the register number and bit number to allow the user to easily identify the register and bit that controls the function. For example, the power on (PON) is in register 0, bit 0. This is represented as *PON (r0x00:b0)*.



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RGBC Operation

The RGBC engine contains RGBC gain control (AGAIN) and four integrating analog-to-digital converters (ADC) for the RGBC photodiodes. The RGBC integration time (ATIME) impacts both the resolution and the sensitivity of the RGBC reading. Integration of all four channels occurs simultaneously and upon completion of the conversion cycle, the results are transferred to the color data registers. This data is also referred to as channel count. The transfers are double-buffered to ensure that invalid data is not read during the transfer. After the transfer, the device automatically moves to the next state in accordance with the configured state machine.

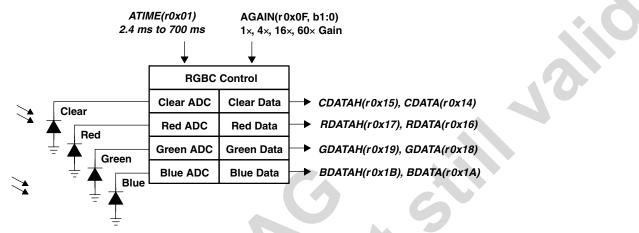


Figure 10. RGBC Operation

The registers for programming the integration and wait times are a 2's compliment values. The actual time can be calculated as follows:

ATIME = 256 – Integration Time / 2.4 ms

Inversely, the time can be calculated from the register value as follows: Integration Time = $2.4 \text{ ms} \times (256 - \text{ATIME})$

For example, if a 100-ms integration time is needed, the device needs to be programmed to: 256 - (100 / 2.4) = 256 - 42 = 214 = 0xD6

Conversely, the programmed value of 0xC0 would correspond to: $(256 - 0xC0) \times 2.4 = 64 \times 2.4 = 154$ ms



Proximity Detection

Proximity detection is accomplished by measuring the amount of light energy, generally from an IR LED, reflected off an object to determine its distance. The proximity light source, which is external to the TCS3772 device, is driven by the integrated proximity LED current driver as shown in Figure 6.

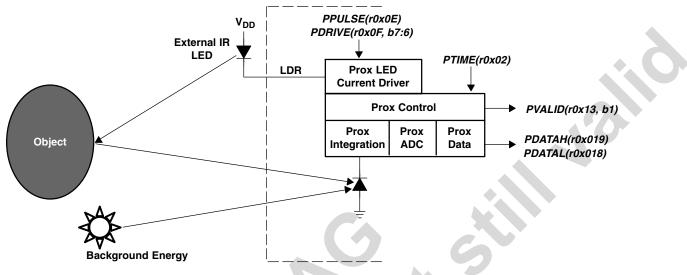


Figure 11. Proximity Detection

The LED current driver, output on the LDR terminal, provides a regulated current sink that eliminates the need for an external current limiting resistor. PDRIVE sets the drive current to 100 mA, 50 mA, 25 mA. To drive an external light source with more than 100 mA or to minimize on-chip ground bounce, LDR can be used to drive an external p-type transistor, which, in turn, drives the light source.

Referring to the Detailed State Machine figure, the LED current driver pulses the external IR LED as shown in Figure 12 during the Prox Accum state. Figure 12 also illustrates that the LED On pulse has a fixed width of 6.3 μ s and period of 14.0 μ s. So, in addition to setting the proximity drive current, 1 to 255 proximity pulses (PPULSE) can be programmed. When deciding on the number of proximity pulses, keep in mind that the signal increases proportionally to PPULSE, while noise increases by the square root of PPULSE.

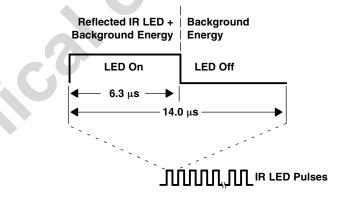


Figure 12. Proximity LED Current Driver Waveform

Figure 11 illustrates light rays emitting from an external IR LED, reflecting off an object, and being absorbed by the proximity photodiode.



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Referring again to Figure 12, the reflected IR LED and the background energy is integrated during the LED On time, then during the LED Off time, the integrated background energy is subtracted from the LED On time energy, leaving the external IR LED energy to accumulate from pulse to pulse.

After the programmed number of proximity pulses have been generated, the proximity ADC converts and scales the proximity measurement to a 16-bit value, then stores the result in two 8-bit proximity data (PDATAx) registers. ADC scaling is controlled by the proximity ADC conversion time (PTIME) which is programmable from 1 to 256 2.4-ms time units. However, depending on the application, scaling the proximity data will equally scale any accumulated noise. Therefore, in general, it is recommended to leave PTIME at the default value of one 2.4-ms ADC conversion time (0xFF).

Once the first proximity cycle has completed, the proximity valid (PVALID) bit in the Status register will be set and remain set until the proximity detection function is disabled (PEN).

For additional information on using the proximity detection function behind glass and for optical system design guidance, please see available TAOS application notes.



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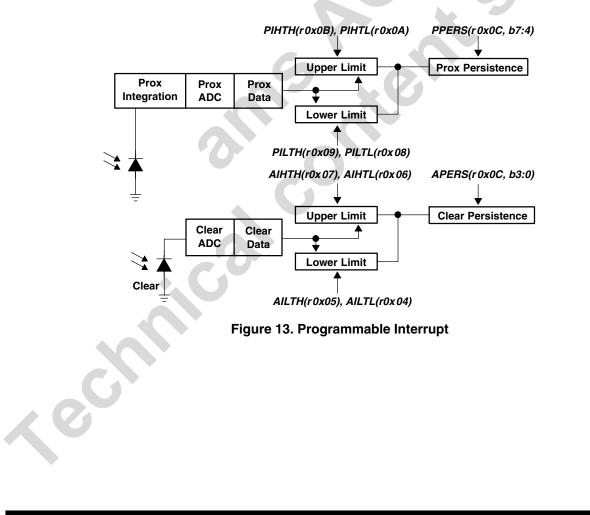
Interrupts

The interrupt feature simplifies and improves system efficiency by eliminating the need to poll the sensor for light intensity or proximity values outside of a user-defined range. While the interrupt function is always enabled and it's status is available in the status register (0x13), the output of the interrupt state can be enabled using the proximity interrupt enable (PIEN) or Clear interrupt enable (AIEN) fields in the enable register (0x00).

Four 16-bit interrupt threshold registers allow the user to set limits below and above a desired light level and proximity range. An interrupt can be generated when the Clear data (CDATA) is less than the Clear interrupt low threshold registers (AILTx) or greater than the Clear interrupt high threshold registers (AIHTx). Likewise, an out-of-range proximity interrupt can be generated when the proximity data (PDATA) falls below the proximity interrupt low threshold (PILTx) or exceeds the proximity interrupt high threshold (PIHTx).

It is important to note that the thresholds are evaluated in sequence, first the low threshold, then the high threshold. As a result, if the low threshold is set above the high threshold, the high threshold is ignored and only the low threshold is evaluated.

To further control when an interrupt occurs, the device provides a persistence filter. The persistence filter allows the user to specify the number of consecutive out-of-range Clear or proximity occurrences before an interrupt is generated. The persistence register (0x0C) allows the user to set the Clear persistence (APERS) and the proximity persistence (PPERS) values. See the persistence register for details on the persistence filter values. Once the persistence filter generates an interrupt, it will continue until a special function interrupt clear command is received (see command register).





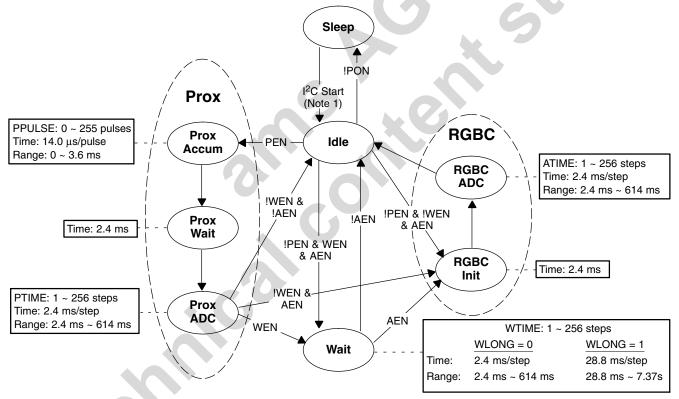
System Timing

The system state machine shown in Figure 9 provides an overview of the states and state transitions that provide system control of the device. This section highlights the programmable features, which affect the state machine cycle time, and provides details to determine system level timing.

When the proximity detection feature is enabled (PEN), the state machine transitions through the Prox Accum, Prox Wait, and Prox ADC states. The Prox Wait time is a fixed 2.4 ms, whereas the Prox Accum time is determined by the number of proximity LED pulses (PPULSE) and the Prox ADC time is determined by the integration time (PTIME). The formulas to determine the Prox Accum and Prox ADC times are given in the associated boxes in Figure 14. If an interrupt is generated as a result of the proximity cycle, it will be asserted at the end of the Prox ADC state.

When the power management feature is enabled (WEN), the state machine will transition in turn to the Wait state. The wait time is determined by WLONG, which extends normal operation by 12× when asserted, and WTIME. The formula to determine the wait time is given in the box associated with the Wait state in Figure 14.

When the RGBC feature is enabled (AEN), the state machine will transition through the RGBC Init and RGBC ADC states. The RGBC Init state takes 2.4 ms, while the RGBC ADC time is dependent on the integration time (ATIME). The formula to determine RGBC ADC time is given in the associated box in Figure 14. If an interrupt is generated as a result of the RGBC cycle, it will be asserted at the end of the RGBC ADC.



Notes: 1. There is a 2.4 ms warm-up delay if PON is enabled. If PON is not enabled, the device will return to the Sleep state as shown. 2. PON, PEN, WEN, and AEN are fields in the Enable register (0x00).





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Power Management

Power consumption can be managed with the Wait state, because the Wait state typically consumes only 65 μ A of I_{DD} current. An example of the power management feature is given below. With the assumptions provided in the example, average I_{DD} is estimated to be 186 μ A.

SYSTEM STATE MACHINE STATE	PROGRAMMABLE PARAMETER	PROGRAMMED VALUE	DURATION	TYPICAL CURRENT
Prox Accum	PPULSE	0x04	0.056 ms	
Prox Accum – LED On			0.025 ms (Note 1)	109 mA
Prox Accum – LED Off			0.031 ms (Note 2)	0.235 mA
Prox Wait			2.40 ms	0.235 mA
Prox ADC	PTIME	0xFF	2.40 ms	0.235 mA
147 1	WTIME	0xEE		0.005
Wait	WLONG	0	43.1 ms	0.065 mA
ALS Init			2.40 ms	0.235 mA
ALS ADC	ATIME	0xEE	43.1 ms	0.235 mA

Table	1.	Power	Management
10010			Juna genient

NOTES: 1. Prox Accum – LED On time = 6.3 μs per pulse × 4 pulses = 25.2μs = 0.025 ms 2. Prox Accum – LED Off time = 7.7 μs per pulse × 4 pulses = 30.9μs = 0.031 ms

Average I_{DD} Current = ((0.025 × 109) + (0.031 × 0.235) + (2.40 × 0.235) +

 $(43.1 \times 0.065) + (43.1 \times 0.263) + (2.40 \times 0.235 \times 2)) / 93 \approx 186 \,\mu\text{A}$

Keeping with the same programmed values as the example, Table 2 shows how the average I_{DD} current is affected by the Wait state time, which is determined by WEN, WTIME, and WLONG. Note that the worst-case current occurs when the Wait state is not enabled.

WEN	WTIME	WLONG	WAIT STATE	AVERAGE IDD CURRENT
0	n/a	n/a	0 ms	289 μΑ
1	0xFF	0	2.40 ms	279 μΑ
1	0xEE	0	43.1 ms	186 μΑ
1	0x00	0	613 ms	82 μΑ
1	0x00	1	7.36 s	67 μΑ

Table 2. Average IDD Current

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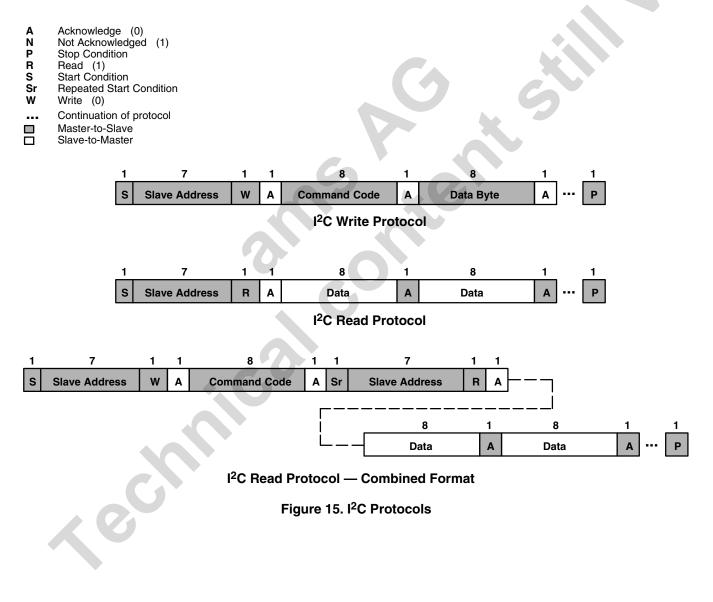


I²C Protocol

Interface and control are accomplished through an I^2C serial compatible interface (standard or fast mode) to a set of registers that provide access to device control functions and output data. The devices support the 7-bit I^2C addressing protocol.

The I²C standard provides for three types of bus transaction: read, write, and a combined protocol (Figure 15). During a write operation, the first byte written is a command byte followed by data. In a combined protocol, the first byte written is the command byte followed by reading a series of bytes. If a read command is issued, the register address from the previous command will be used for data access. Likewise, if the MSB of the command is not set, the device will write a series of bytes at the address stored in the last valid command with a register address. The command byte contains either control information or a 5-bit register address. The control commands can also be used to clear interrupts.

The I²C bus protocol was developed by Philips (now NXP). For a complete description of the I²C protocol, please review the NXP I²C design specification at http://www.i2c-bus.org/references/.





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Register Set

The TCS3772 is controlled and monitored by data registers and a command register accessed through the serial interface. These registers provide for a variety of control functions and can be read to determine results of the ADC conversions. The register set is summarized in Table 3.

ADDRESS	RESISTER NAME	R/W	REGISTER FUNCTION	RESET VALUE
	COMMAND	W	Specifies register address	0x00
0x00	ENABLE	R/W	Enables states and interrupts	0x00
0x01	ATIME	R/W	RGBC time	0xFF
0x02	PTIME	R/W	Proximity time	0xFF
0x03	WTIME	R/W	Wait time	0xFF
0x04	AILTL	R/W	Clear interrupt low threshold low byte	0x00
0x05	AILTH	R/W	Clear interrupt low threshold high byte	0x00
0x06	AIHTL	R/W	Clear interrupt high threshold low byte	0x00
0x07	AIHTH	R/W	Clear interrupt high threshold high byte	0x00
0x08	PILTL	R/W	Proximity interrupt low threshold low byte	0x00
0x09	PILTH	R/W	Proximity interrupt low threshold high byte	0x00
0x0A	PIHTL	R/W	Proximity interrupt high threshold low byte	0x00
0x0B	PIHTH	R/W	Proximity interrupt high threshold high byte	0x00
0x0C	PERS	R/W	Interrupt persistence filters	0x00
0x0D	CONFIG	R/W	Configuration	0x00
0x0E	PPULSE	R/W	Proximity pulse count	0x00
0x0F	CONTROL	R/W	Gain control register	0x00
0x12	ID	R	Device ID	ID
0x13	STATUS	R	Device status	0x00
0x14	CDATA	R	Clear ADC data low byte	0x00
0x15	CDATAH	R	Clear ADC data high byte	0x00
0x16	RDATA	R	Red ADC data low byte	0x00
0x17	RDATAH	R	Red ADC data high byte	0x00
0x18	GDATA	R	Green ADC data low byte	0x00
0x19	GDATAH	R	Green ADC data high byte	0x00
0x1A	BDATA	R	Blue ADC data low byte	0x00
0x1B	BDATAH	R	Blue ADC data high byte	0x00
0x1C	PDATA	R	Proximity ADC data low byte	0x00
0x1D	PDATAH	R	Proximity ADC data high byte	0x00

Table 3. Register Address

The mechanics of accessing a specific register depends on the specific protocol used. See the section on I²C protocols on the previous pages. In general, the COMMAND register is written first to specify the specific control/status register for following read/write operations.



Command Register

The command registers specifies the address of the target register for future write and read operations.

FIELD BITS DESCRIPTION CMD 7 Select Command Register. Must write as 1 when addressing COMMAND register. TYPE 6:5 Selects type of transaction to follow in subsequent data transfers: FIELD VALUE INTEGRATION TIME 00 Repeated byte protocol transaction 01 Auto-increment protocol transaction 01 Reserved — Do not use 10 Reserved — Do not use Block protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function refield. Depending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for following write and read transactions. The field value listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00110 Clear interrupt clear 00111 Proximity and Clear interrupt clear 00110 Clear special functions clear any pending interrupt(s) and are self clearing.		7	6 5	4 table 4.	3	2	1	0	
CMD 7 Select Command Register. Must write as 1 when addressing COMMAND register. TYPE 6:5 Selects type of transaction to follow in subsequent data transfers: FIELD VALUE INTEGRATION TIME 00 Repeated byte protocol transaction 01 Auto-increment protocol transaction 10 Reserved — Do not use 11 Special function — See description below Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function field. Depending on the transaction commands: FIELD VALUE READ VALUE Very protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function field. Depending on the transaction type, see above, this field either specific contol-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt (s) and are self clearing.		СМД	ТҮРЕ			ADDR/SF			
CMD 7 Select Command Register. Must write as 1 when addressing COMMAND register. TYPE 6:5 Selects type of transaction to follow in subsequent data transfers: FIELD VALUE INTEGRATION TIME 00 Repeated byte protocol transaction 01 Auto-increment protocol transaction 10 Reserved — Do not use 11 Special function — See description below Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function field. Depending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for following write and transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00110 Clear channel interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt(s) and are self clearing.	FIELD	BITS			DES	CRIPTION			
TYPE 6:5 Selects type of transaction to follow in subsequent data transfers: FIELD VALUE INTEGRATION TIME 00 Repeated byte protocol transaction 01 Auto-increment protocol transaction 10 Reserved Do not use 11 Special function See description below Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function for read successive bytes. Address field/special function read to be pending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00110 Clear interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt (s) and are self clearing.			Select Command	Register, Must w			OMMAND re	aister	
FIELD VALUE INTEGRATION TIME 00 Repeated byte protocol transaction 01 Auto-increment protocol transaction 10 Reserved — Do not use 11 Special function — See description below Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function field. Depending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for follomy write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 0010 Proximity interrupt clear 0011 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt (s) and are self clearing.				-				gioton.	
00 Repeated byte protocol transaction 01 Auto-increment protocol transaction 10 Reserved — Do not use 11 Special function — See description below Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function field. Depending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00111 Proximity and Clear interrupt (s) and are self clearing.		0.0			cubecqueri				
01 Auto-increment protocol transaction 10 Reserved — Do not use 11 Special function — See description below Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function field. Depending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00110 Clear channel interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear any pending interrupt(s) and are self clearing.					Repea			on	
10 Reserved — Do not use 11 Special function — See description below Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function of memand or selects the specific control-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear any pending interrupt(s) and are self clearing.					•	, ,			
Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes. ADDR/SF 4:0 Address field/special function field. Depending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00110 Clear channel interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear other Reserved — Do not write The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.									
ADDR/SF 4:0 Address field/special function field. Depending on the transaction type, see above, this field either specifies a special function command or selects the specific control-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00110 Clear channel interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear 0111 Proximity and Clear interrupt clear 0112 Reserved — Do not write The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.			11	-	Special fu	unction — See	e description	below	
specifics a special function command or selects the specific control-status-register for following write and read transactions. The field values listed below apply only to special function commands: FIELD VALUE READ VALUE 00101 Proximity interrupt clear 00110 Clear channel interrupt clear 00111 Proximity and Clear interrupt clear 00111 Proximity and Clear interrupt clear 00111 The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.			Byte protocol will Block protocol will	repeatedly read th provide auto-incr	e same registerement function	er with each on to read succ	data access. cessive bytes		
00101 Proximity interrupt clear 00110 Clear channel interrupt clear 00111 Proximity and Clear interrupt clear other Reserved — Do not write The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.	ADDR/SF	4:0	specifies a specia	I function comma	nd or selects th	he specific co	ntrol_status_	register for fo	ullowing write
00110 Clear channel interrupt clear 00111 Proximity and Clear interrupt clear other Reserved — Do not write The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.			FIELD VALUE			READ V	ALUE		
00111 Proximity and Clear interrupt clear other Reserved — Do not write The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.			00101		F	Proximity inte	rrupt clear		
other Reserved — Do not write The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.			00110				-		
The ALS and Proximity interrupt clear special functions clear any pending interrupt(s) and are self clearing.			00111						
				2					

Table 4. Command Register



Enable Register (0x00)

The Enable register is used primarily to power the TCS3772 device on and off, and enable functions and interrupts as shown in Table 5.

FIELDBITSReserved7:6PIEN5AIEN4WEN3PEN2AEN1PON0	Proximity in Clear chann Wait enable wait timer. Proximity e disables pro RGBC enal RGBC. Power ON. Writing a 1	enable. This bi roximity. ble. This bit activa . This bit activa activates the c	nable. When ivates the wai it activates the actives the two	rted, permits p asserted, pern it feature. Wri e proximity fur p-channel ADC	mits Clear inte ting a 1 activa nction. Writing	errupts to be g ates the wait ting g a 1 enables	enerated. mer. Writing				
FIELDBITSReserved7:6PIEN5AIEN4WEN3PEN2AEN1	Reserved. Proximity in Clear chann Wait enable wait timer. Proximity e disables pro RGBC enable RGBC. Power ON. Writing a 1	Write as 0. Interrupt enable inel interrupt er e. This bit active roximity. ble. This bit active activates the o	e. When asse nable. When ivates the wai it activates the actives the two	DESC rted, permits p asserted, permit it feature. Wri e proximity fur p-channel ADC	CRIPTION proximity inter mits Clear inter ting a 1 active nction. Writing	rupts to be ge errupts to be g ates the wait ti g a 1 enables	nerated. enerated. mer. Writing	a 0 disables the			
Reserved7:6PIEN5AIEN4WEN3PEN2AEN1	Proximity in Clear chann Wait enable wait timer. Proximity e disables pro RGBC enal RGBC. Power ON. Writing a 1	nterrupt enable nel interrupt er e. This bit acti enable. This bi roximity. ble. This bit activa activates the c	nable. When ivates the wai it activates the actives the two	rted, permits p asserted, pern it feature. Wri e proximity fur p-channel ADC	proximity inter mits Clear inter ting a 1 active nction. Writing	errupts to be g ates the wait ting g a 1 enables	enerated. mer. Writing				
PIEN5AIEN4WEN3PEN2AEN1	Proximity in Clear chann Wait enable wait timer. Proximity e disables pro RGBC enal RGBC. Power ON. Writing a 1	nterrupt enable nel interrupt er e. This bit acti enable. This bi roximity. ble. This bit activa activates the c	nable. When ivates the wai it activates the actives the two	asserted, per it feature. Wri e proximity fur p-channel ADC	mits Clear inte ting a 1 activa nction. Writing	errupts to be g ates the wait ting g a 1 enables	enerated. mer. Writing				
AIEN4WEN3PEN2AEN1	Clear chann Wait enable wait timer. Proximity e disables pro RGBC enab RGBC. Power ON. Writing a 1	nel interrupt er e. This bit acti enable. This bi roximity. ble. This bit activa activates the c	nable. When ivates the wai it activates the actives the two	asserted, per it feature. Wri e proximity fur p-channel ADC	mits Clear inte ting a 1 activa nction. Writing	errupts to be g ates the wait ting g a 1 enables	enerated. mer. Writing	a 0 disables the Vriting a 0			
WEN 3 PEN 2 AEN 1	Wait enable wait timer. Proximity e disables pro RGBC enal RGBC. Power ON. Writing a 1	e. This bit acti enable. This bi roximity. ble. This bit activa activates the c	ivates the wai it activates the actives the two	it feature. Wri e proximity fur p-channel ADC	ting a 1 activa	ates the wait ting a 1 enables	mer. Writing				
PEN 2 AEN 1	wait timer. Proximity e disables pro RGBC enal RGBC. Power ON. Writing a 1	enable. This bi roximity. ble. This bit activa . This bit activa activates the c	it activates the	e proximity fur o-channel ADC	nction. Writing	g a 1 enables					
AEN 1	disables pro RGBC enal RGBC. Power ON. Writing a 1	roximity. ble. This bit active . This bit active activates the	actives the two	o-channel ADC			proximity. W	/riting a 0			
	RGBC. Power ON. Writing a 1	. This bit active			C. Writing a 1						
PON 0	Power ON. Writing a 1 interface, th	This bit active activates the case of the terms of ter	ates the interi		RGBC enable. This bit actives the two-channel ADC. Writing a 1 activates RGBC. Writing a 0 disables RGBC.						
		Power ON. This bit activates the internal oscillator to permit the timers and ADC channels to operate. Writing a 1 activates the oscillator. Writing a 0 disables the oscillator. During reads and writes over the I ² C interface, this bit is temporarily overridden and the oscillator is enabled, independent of the state of PON.									
		20	S								

Table 5. Enable Register





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RGBC Time Register (0x01)

The RGBC timing register controls the internal integration time of the RGBC clear and IR channel ADCs in 2.4-ms increments. Upon power up, the RGBC time register is set to 0xFF.

FIELD	BITS	DESCRIPTION					
ATIME	7:0	VALUE	INTEG_CYCLES	TIME	MAX COUNT		
		0xFF	1	2.4 ms	1024		
		0xF6	10	24 ms	10240		
		0xD6	42	101 ms	43008		
		0xAD	64	154 ms	65535		
		0x00	256	614 ms	65535		

Table 6. RGBC Time Register

Proximity Time Register (0x02)

The proximity timing register controls the integration time of the proximity ADC in 2.4 ms increments. Upon power up, the proximity time register is set to 0xFF. It is recommended that this register be programmed to a value of 0xFF (1 integration cycle).

Max Prox Count = $((256 - PTIME) \times 1024)) - 1$ up to a maximum of 65535

Table 7. Proximity Time Register

FIELD	BITS		DESCR	IPTION	
PTIME	7:0	VALUE	INTEG_CYCLES	ТІМЕ	MAX COUNT
		0xFF	1	2.4 ms	1023

Wait Time Register (0x03)

Wait time is set 2.4 ms increments unless the WLONG bit is asserted in which case the wait times are 12× longer. WTIME is programmed as a 2's complement number. Upon power up, the wait time register is set to 0xFF.

Table 8. Wait Time Register

FIELD	BITS	DESCRIPTION				
WTIME	7:0	REGISTER VALUE	WAIT TIME	TIME (WLONG = 0)	TIME (WLONG = 1)	
		0xFF	1	2.4 ms	0.029 sec	
		0xAB	85	204 ms	2.45 sec	
		0x00	256	614 ms	7.4 sec	

NOTE: The Proximity Wait Time Register should be configured before PEN and/or AEN is/are asserted.



Clear Interrupt Threshold Registers (0x04 – 0x07)

The Clear interrupt threshold registers provides the values to be used as the high and low trigger points for the comparison function for interrupt generation. If the value generated by the clear channel crosses below the lower threshold specified, or above the higher threshold, an interrupt is asserted on the interrupt pin.

REGISTER	ADDRESS	BITS	DESCRIPTION		
AILTL	0x04	7:0	Clear channel low threshold lower byte	٠.	
AILTH	0x05	7:0	Clear channel low threshold upper byte		
AIHTL	0x06	7:0	Clear channel high threshold lower byte		
AIHTH	0x07	7:0	0 Clear channel high threshold upper byte		

Table 9. Clear Interrupt Threshold Registers

Proximity Interrupt Threshold Registers (0x08 – 0x0B)

The proximity interrupt threshold registers provide the values to be used as the high and low trigger points for the comparison function for interrupt generation. If the value generated by proximity channel crosses below the lower threshold specified, or above the higher threshold, an interrupt is signaled to the host processor.

REGISTER	ADDRESS BITS DESCRIPTION					
PILTL	0x08	7:0	Proximity ADC channel low threshold lower byte			
PILTH	0x09	7:0	Proximity ADC channel low threshold upper byte			
PIHTL	0x0A	7:0	Proximity ADC channel high threshold lower byte			
PIHTH	PIHTH 0x0B 7:0 Proximity ADC channel high threshold upper byte					
		2				

Table 10. Proximity Interrupt Threshold Registers

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Persistence Filter Register (0x0C)

The persistence filter register controls the filtering interrupt capabilities of the device. Configurable filtering is provided to allow interrupts to be generated after each integration cycle or if the integration has produced a result that is outside of the values specified by the threshold register for some specified amount of time. Separate filtering is provided for proximity and the clear channel.

	7	6	5 4	3	2	1	0			
is 🗌		PPERS			AP	ERS		Reset 0x00		
FIELD	BITS			DES	CRIPTION					
PPERS	7:4	Proximity interr	upt persistence. Co	ntrols rate of pr	oximity interru	upt to the hos	t processor.			
		FIELD VALUE								
		0000	Every proximit	y cycle generat	es an interrup	ot				
		0001	1 proximity val	ue out of range	ł					
		0010	2 consecutive	proximity value	s out of range)				
		1111	15 consecutive	e proximity valu	es out of rang	je				
APERS	3:0	Clear Interrupt	persistence. Contro	rsistence. Controls rate of Clear channel interrupt to the host processor.						
		FIELD VALUE	E	INTERR	UPT PERSIS	TENCE FUN	CTION			
		0000	Every RGBC of	Every RGBC cycle generates an interrupt						
		0001 1 clear channel value outside of threshold range								
		0010	2 clear channel consecutive values out of range							
		0011	3 clear channe	el consecutive v	alues out of r	ange				
		0100	5 clear channe	el consecutive v	alues out of r	ange				
		0101	10 clear chanr	nel consecutive	values out of	range				
		0110	15 clear chanr	nel consecutive	values out of	range				
		0111	20 clear chann	nel consecutive	values out of	range				
		1000	25 clear chanr	nel consecutive	values out of	range				
		1001	30 clear chanr	nel consecutive	values out of	range				
		1010	35 clear chann	nel consecutive	values out of	range				
		1011	40 clear chanr	nel consecutive	values out of	range				
		1100	45 clear chanr	nel consecutive	values out of	range				
		1101	50 clear chanr	nel consecutive	values out of	range				
		1110	55 clear chanr	nel consecutive	values out of	range				
		1111	60 clear chanr	nel consecutive	values out of	range				

Table 11. Persistence Filter Register



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Configuration Register (0x0D)

The configuration register sets the wait long time.

Table 12. Configuration Register										
	7	6	5	4	3	2	1	0		
CONFIG			Reserved WLONG Reserved Reserved Reserved							
FIELD	BITS		DESCRIPTION							
Reserved	7:2	Reserved.	Write as 0.							
WLONG	1		Wait Long. When asserted, the wait cycles are increased by a factor $12 \times$ from that programmed in the WTIME register.							
Reserved	0	Reserved.	Reserved. Write as 0.							

Proximity Pulse Count Register (0x0E)

The proximity pulse count register sets the number of proximity pulses that will be transmitted.

Table 13. Proximity Pulse Count Register

	7	6	5	4 3	2	1	0	
PPULSE				PPULSE				Reset 0x00
FIELD	BITS			DES	CRIPTION			
PPULSE	7:0	Proximity Puls	se Count. Sp	pecifies the number of pro	pximity pulses to	be generated	d.	

<u> </u>	



Control Register (0x0F)

The Control register provides eight bits of miscellaneous control to the analog block.

			Table ⁻	14. Cor	trol Regi	ster				
	7	6	5	4	3	2	1	0		
CONTROL	PDRIVE	E		Res	erved		A	GAIN	Reset 0x00	
FIELD	BITS		DESCRIPTION							
PDRIVE	7:6	Proximity LED	Drive Strer	ngth.						
		FIELD VALU	JE			LED ST	RENGTH			
		00	100 m	۱A						
		01	50 m/	4						
		10	25 m/	4						
		11	12.5 r	nA						
Reserved	5:2	Reserved. Write bits as 0								
AGAIN	1:0	RGBC Gain C	ontrol.							
		FIELD VALU	JE			RGBC GA	IN VALUE			
		00	1× ga	iin						
		01	4× ga	lin						
		10	16× g	Jain						
		11	60× g	Jain						

ID Register (0x12)

ID

7:0

261

The ID Register provides the value for the part number. The ID register is a read-only register.

Part number identification

Table 15. ID Register

	7	6	5	4 3	2	1	0	
ID				ID				Reset ID
FIELD	BITS			DESC	RIPTION			
						0x40 = T0	CS37721 & 1	CS37725



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0x49 = TCS37723 & TCS37727

Status Register (0x13)

The Status Register provides the internal status of the device. This register is read only.

	7	6	5	4	3	2	1	0			
STATUS	Res	served	PINT	AINT	Rese	erved	PVALID	AVALID	Reset 0x00		
FIELD	BIT				DESC	RIPTION					
Reserved	7:6	Reserved.	leserved.								
PINT	5	Proximity In	Proximity Interrupt.								
AINT	4	Clear chann	Clear channel Interrupt.								
Reserved	3:2	Reserved.	Reserved.								
PVALID	1	Proximity Valid. Indicates that a proximity cycle has completed since PEN was asserted.									
AVALID	0	RGBC Valid. Indicates that the RGBC cycle has completed since AEN was asserted.									

Table 16. Status Register

RGBC Channel Data Registers (0x14 – 0x1B)

Clear, red, green, and blue data is stored as 16-bit values. To ensure the data is read correctly, a two-byte read I²C transaction should be used with a read word protocol bit set in the command register. With this operation, when the lower byte register is read, the upper eight bits are stored into a shadow register, which is read by a subsequent read to the upper byte. The upper register will read the correct value even if additional ADC integration cycles end between the reading of the lower and upper registers.

REGISTER	REGISTER ADDRESS BITS		DESCRIPTION		
CDATA	0x14	7:0	Clear data low byte		
CDATAH	0x15	7:0	Clear data high byte		
RDATA	0x16	7:0	Red data low byte		
RDATAH	0x17	7:0	Red data high byte		
GDATA	0x18	7:0	Green data low byte		
GDATAH	0x19	7:0	Green data high byte		
BDATA	0x1A	7:0	Blue data low byte		
BDATAH	0x1B	7:0	Blue data high byte		

Table 17. ADC Channel Data Registers

Proximity Data Registers (0x1C - 0x1D)

Proximity data is stored as a 16-bit value. To ensure the data is read correctly, a two-byte read I²C transaction should be used with a read word protocol bit set in the command register. With this operation, when the lower byte register is read, the upper eight bits are stored into a shadow register, which is read by a subsequent read to the upper byte. The upper register will read the correct value even if additional ADC integration cycles end between the reading of the lower and upper registers.

			-
REGISTER	ADDRESS	BITS	DESCRIPTION
PDATA	0x1C	7:0	Proximity data low byte
PDATAH	0x1D	7:0	Proximity data high byte

Table 18. PDATA Registers

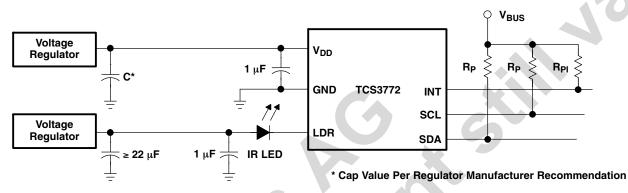
The LUMENOLOGY ® Company

APPLICATION INFORMATION: HARDWARE

LED Driver Pin with Proximity Detection

In a proximity sensing system, the IR LED can be pulsed by the TCS3772 with more than 100 mA of rapidly switching current, therefore, a few design considerations must be kept in mind to get the best performance. The key goal is to reduce the power supply noise coupled back into the device during the LED pulses.

The first recommendation is to use two power supplies; one for the device V_{DD} and the other for the IR LED. In many systems, there is a quiet analog supply and a noisy digital supply. By connecting the quiet supply to the V_{DD} pin and the noisy supply to the LED, the key goal can be meet. Place a 1-µF low-ESR decoupling capacitor as close as possible to the V_{DD} pin and another at the LED anode, and a 22-µF capacitor at the output of the LED voltage regulator to supply the 100-mA current surge.





If it is not possible to provide two separate power supplies, the device can be operated from a single supply. A 22- Ω resistor in series with the V_{DD} supply line and a 1- μ F low ESR capacitor effectively filter any power supply noise. The previous capacitor placement considerations apply.

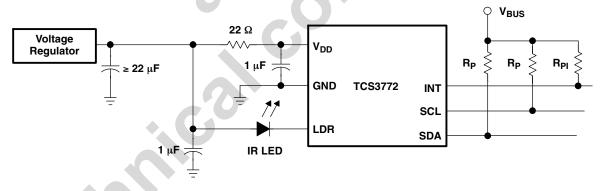


Figure 17. Proximity Sensing Using Single Power Supply

V_{BUS} in the above figures refers to the I²C bus voltage which is either V_{DD} or 1.8 V. Be sure to apply the specified I²C bus voltage shown in the Available Options table for the specific device being used.

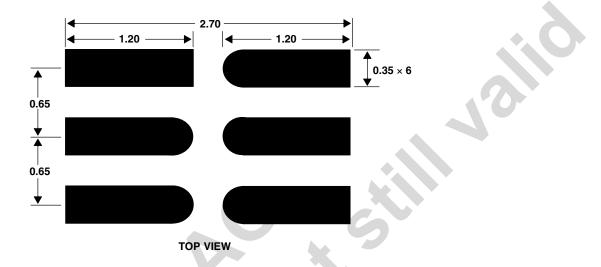
The I²C signals and the Interrupt are open-drain outputs and require pull–up resistors. The pull-up resistor (R_P) value is a function of the I²C bus speed, the I²C bus voltage, and the capacitive load. The TAOS EVM running at 400 kbps, uses $1.5 \cdot k\Omega$ resistors. A $10 \cdot k\Omega$ pull-up resistor (R_P) can be used for the interrupt line.



APPLICATION INFORMATION: HARDWARE

PCB Pad Layout

Suggested land pattern based on the IPC–7351B Generic Requirements for Surface Mount Design and Land Pattern Standard (2010) for the small outline no-lead (SON) package is shown in Figure 18.



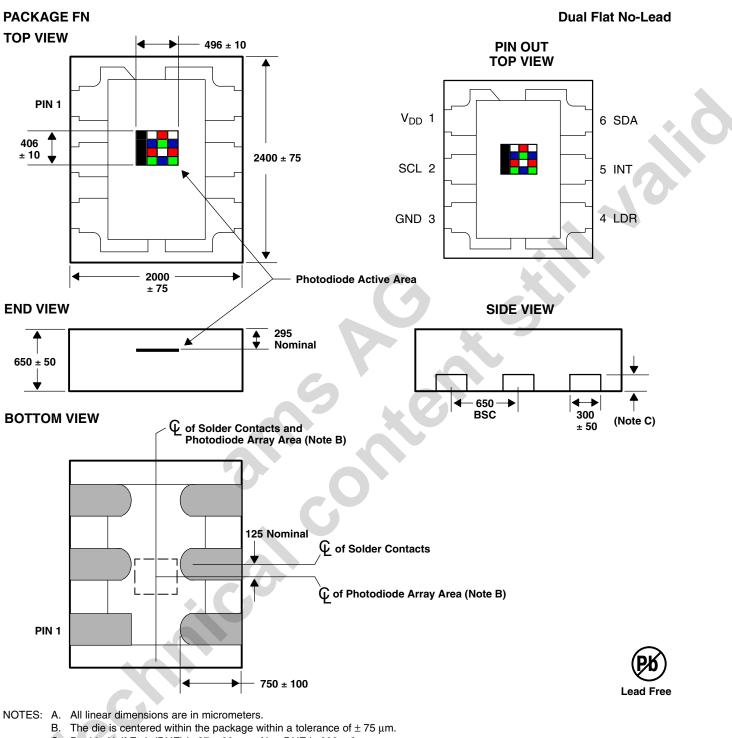
- NOTES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.

Figure 18. Suggested FN Package PCB Layout



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PACKAGE INFORMATION



- C. Double-Half Etch (DHE) is 97 \pm 20 μ m. Non-DHE is 203 \pm 8 μ m.
- D. Package top surface is molded with an electrically nonconductive clear plastic compound having an index of refraction of 1.55.
- E. Contact finish is copper alloy A194 with pre-plated NiPdAu lead finish.
- F. This package contains no lead (Pb).
- G. This drawing is subject to change without notice.

Figure 19. Package FN — Dual Flat No-Lead Packaging Configuration

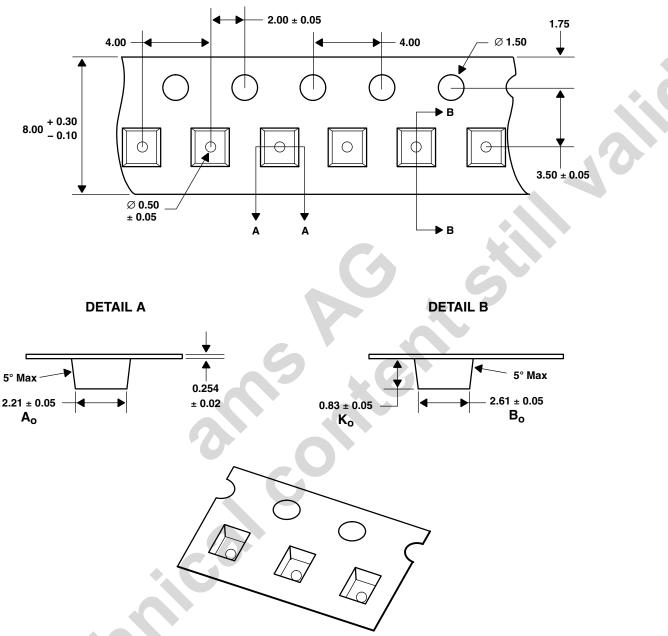
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TAOS145B - SEPTEMBER 2012

CARRIER TAPE AND REEL INFORMATION



- NOTES: A. All linear dimensions are in millimeters. Dimension tolerance is ± 0.10 mm unless otherwise noted.
 - B. The dimensions on this drawing are for illustrative purposes only. Dimensions of an actual carrier may vary slightly.
 - C. Symbols on drawing A_o, B_o, and K_o are defined in ANSI EIA Standard 481-B 2001.
 - D. Each reel is 178 millimeters in diameter and contains 3500 parts.
 - E. TAOS packaging tape and reel conform to the requirements of EIA Standard 481-B.
 - F. In accordance with EIA standard, device pin 1 is located next to the sprocket holes in the tape.
 - G. This drawing is subject to change without notice.

Figure 20. Package FN Carrier Tape

TOP VIEW



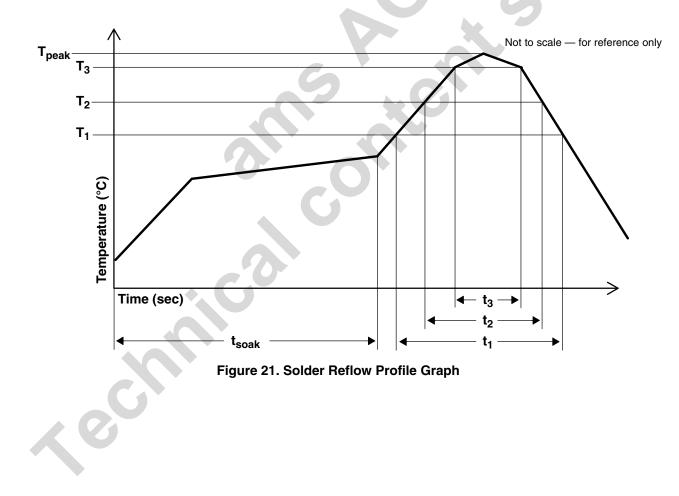
SOLDERING INFORMATION

The FN package has been tested and has demonstrated an ability to be reflow soldered to a PCB substrate.

The solder reflow profile describes the expected maximum heat exposure of components during the solder reflow process of product on a PCB. Temperature is measured on top of component. The components should be limited to a maximum of three passes through this solder reflow profile.

PARAMETER	REFERENCE	TCS3772
Average temperature gradient in preheating		2.5°C/sec
Soak time	t _{soak}	2 to 3 minutes
Time above 217°C (T1)	t ₁	Max 60 sec
Time above 230°C (T2)	t ₂	Max 50 sec
Time above T _{peak} -10°C (T3)	t ₃	Max 10 sec
Peak temperature in reflow	T _{peak}	260°C
Temperature gradient in cooling		Max –5°C/sec







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STORAGE INFORMATION

Moisture Sensitivity

Optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package. To ensure the package contains the smallest amount of absorbed moisture possible, each device is baked prior to being dry packed for shipping. Devices are dry packed in a sealed aluminized envelope called a moisture-barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

Shelf Life

The calculated shelf life of the device in an unopened moisture barrier bag is 12 months from the date code on the bag when stored under the following conditions:

Shelf Life: 12 months Ambient Temperature: < 40°C Relative Humidity: < 90%

Rebaking of the devices will be required if the devices exceed the 12 month shelf life or the Humidity Indicator Card shows that the devices were exposed to conditions beyond the allowable moisture region.

Floor Life

The FN package has been assigned a moisture sensitivity level of MSL 3. As a result, the floor life of devices removed from the moisture barrier bag is 168 hours from the time the bag was opened, provided that the devices are stored under the following conditions:

Floor Life: 168 hours Ambient Temperature: < 30°C Relative Humidity: < 60%

If the floor life or the temperature/humidity conditions have been exceeded, the devices must be rebaked prior to solder reflow or dry packing.

Rebaking Instructions

When the shelf life or floor life limits have been exceeded, rebake at 50°C for 12 hours.





PRODUCTION DATA — information in this document is current at publication date. Products conform to specifications in accordance with the terms of Texas Advanced Optoelectronic Solutions, Inc. standard warranty. Production processing does not necessarily include testing of all parameters.

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Green (RoHS & no Sb/Br) TAOS defines *Green* to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material).

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